

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

I RODUCI/I ROCESS CHANGE NOTICE (I CN)						
PCN #: A1603-01 D	ATE: 11-Apr-2016	MEANS OF DISTINGUISHING CHANGED DEVICES:				
Product Affected: 15.0mm x 15.0mm FCE	3GA-196	□ Product Mark				
24.0mm x 15.5mm FCF	3GA-345	☐ Back Mark				
Refer to Attachment II for the affect	cted part numbers	□ Date Code	Assembly lot marked on the device			
		Other	provides traceability to the material			
Date Effective: 11-Jul-2016			used			
Contact: IDT PCN DESK		Attachment:	Yes No			
E-mail: <pre>pcndesk@idt.com</pre>		Samples: Please contact your local sales representative for sample request & availability.				
DESCRIPTION AND PURPOSE OF CHA	NGE:					
☐ Die Technology	This notification is to	advise our customers	that the lid adhesive material will be			
□ Wafer Fabrication Process□ Assembly Process	changed from MD140					
☐ Equipment						
■ Material	_	_				
☐ Testing ☐ Manufacturing Site	Attachment I details the qualification data for this change and Attachment II shows the affected list of part numbers.					
☐ Data Sheet	Attachment II shows	me affected fist of par	it numbers.			
□ Other						
RELIABILITY/QUALIFICATION SUMMARY:						
Refer to qualification data shown in attachment I.						
CUSTOMER ACKNOWLEDGMENT OF	RECEIPT:					
IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail						
to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice						
it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory						
on the earlier version has been depleted.						
Customer:		Approval for s	shipments prior to effective date.			
Name/Date:	 E-	Mail Address:				
CUSTOMER COMMENTS:						
IDT ACKNOWLEDOMENT OF DECEM	yr.					
IDT ACKNOWLEDGMENT OF RECEIP						
RECD. BY:		DATE:				



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ATTACHMENT I - PCN #: A1603-01

PCN Type: Change of Materials

Data Sheet Change: None

No change in moisture sensitivity level (MSL)

Detail Of Change:

This notification is to advise our customers that the lid adhesive material will be changed from MD140 to Henkel CE-3920.

There is no change to the moisture performance of these packages.

Change of Material Set

Description	From	То	
Lid Adhesive Material	MD140	Henkel CE-3920	

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ATTACHMENT I - PCN #: A1603-01

Qualification Test Plans and Results:

Qual Plan & Results: The qualification was performed in accordance with JEDEC47 recommended

tests

Qual Vehicle: 15.0mm x 15.0mm FCBGA-196 (1 lot)

24.0mm x 15.5mm FCBGA-345 (2 lots)

			Test Results (SS / Rej)		
Test Description	Test Method	Lot 1	Lot 2	Lot 3	
* HAST - Unbiased (130 °C/85% RH, 96 Hrs)	JESD22-A118	25/0	25/0	25/0	
* Temperature Cycle / Condition B (-55 °C to +125 °C, 700 Cyc)	JESD22-A104	25/0	25/0	25/0	
High Temp. Storage Test (150 °C, 1000 Hrs)	JESD22-A103	25/0	25/0	25/0	

Note:

^{*} Test requires moisture pre-conditioning sequence per JESD22-A113 prior to stress test

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ATTACHMENT II - PCN #: A1603-01

Affected Part Numbers

Part Number	Part Number	Part Number	Part Number
89HT0816APZCBLG	89HT0816APZCBLGI	89HT0832PZCBLG	89HT0832PZCBLGI
89HT0816APZCBLG8	89HT0816APZCBLGI8	89HT0832PZCBLG8	89HT0832PZCBLGI8